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Kind regards,

Team Nexperia



## IP4769CZ14

VGA interface ESD protection with integrated termination resistors

Rev. 1 — 17 January 2011

**Product data sheet** 

## 1. Product profile

## 1.1 General description

The IP4769CZ14 connects between the Video Graphics Adapter (VGA)/Digital Video Interface (DVI) and the video transmitter like e.g. a PC graphic card or the VGA receiver like e.g. a PC Monitor.

The IP4769CZ14 includes ElectroStatic Discharge (ESD) protection for the Data Display Channel (DDC) signals, DDC level shifting and ESD protection for both SYNChronization (SYNC) lines as well as high-level ESD protection diodes for the Red-Green-Blue (RGB) signal lines.

The DDC level shifting can be used to shift the 5 V DDC bus at the connector side to 3.3 V or 2.5 V on the internal side.

## 1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- Integrated high-level ESD protection and level shifting
- DDC level shifting from 5 V to 3.3 V or 2.5 V
- IEC 61000-4-2, ±4 kV rail-to-rail clamping for each I/O line
- Channel capacitance C<sub>ch</sub> < 4 pF

## **1.3 Applications**

- To reduce ElectroMagnetic Interferences (EMI)/Radio Frequency Interferences (RFI) and to provide downstream ESD protection for:
  - VGA interfaces including DDC channels
  - Desktop and notebook PCs
  - Graphics cards
  - Set-top boxes



## 2. Pinning information

## 2.1 Pinning



## 2.2 Pin description

#### Table 1. Pin description

Symbol	Pin	Description
VIDEO_2	1	video signal ESD protection channel 2
VIDEO_1	2	video signal ESD protection channel 1
V <sub>BIAS_VIDEO</sub>	3	ESD bias voltage for VIDEO_1, VIDEO_2 and VIDEO_3 protection circuit
GND	4	ground
GND	5	ground
V <sub>BIAS_DDC</sub>	6	bias voltage for DDC level shifter N-FET gates
ВҮР	7	optional external 100 nF bypass capacitor to enhance internal zener performance on SYNC_OUT1, SYNC_OUT2, DDC_OUT1 and DDC_OUT2
DDC_OUT1	8	DDC signal output 1; connector side
DDC_IN1	9	DDC signal input 1; VGA controller side
DDC_IN2	10	DDC signal input 2; VGA controller side
DDC_OUT2	11	DDC signal output 2; connector side
SYNC_OUT1	12	SYNC signal output 1; ESD clamp; connector side
SYNC_OUT2	13	SYNC signal output 2; ESD clamp; connector side
VIDEO_3	14	video signal ESD protection channel 3

## 3. Ordering information

Table 2.         Ordering information					
Type number	Package				
	Name	Description	Version		
IP4769CZ14	TSSOP14	plastic shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1		

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## IP4769CZ14

#### VGA interface ESD protection with integrated termination resistors

## 4. Functional diagram



## 5. Limiting values

#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND.

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>ESD</sub>	electrostatic		<u>[1][2]</u>	±6	kV
	discharge voltage	all pins			
			[3] _	±200	V
			[4] _	±2	kV
V <sub>CC(VIDEO)</sub>	video supply voltage		-0.5	5.5	V
V <sub>CC(DDC)</sub>	data display channel supply voltage		-0.5	5.5	V
V <sub>I(VIDEO_2)</sub>	input voltage on pin VIDEO_2		-0.5	V <sub>CC(VIDEO)</sub>	V
V <sub>I(VIDEO_3)</sub>	input voltage on pin VIDEO_3		-0.5	V <sub>CC(VIDEO)</sub>	V
$V_{I(DDC_IN1)}$	input voltage on pin DDC_IN1		-0.5	5.5	V
$V_{I(DDC\_IN2)}$	input voltage on pin DDC_IN2		-0.5	5.5	V
V <sub>O(DDC_OUT1)</sub>	output voltage on pin DDC_OUT1		-0.5	5.5	V
V <sub>O(DDC_OUT2)</sub>	output voltage on pin DDC_OUT2		-0.5	5.5	V
T <sub>stg</sub>	storage temperature		-55	+125	°C

[1] BYP, VCC\_VIDEO and VCC\_SYNC must be bypassed to GND via a low impedance ground plane with 100 nF, low inductance, chip ceramic capacitor at each supply pin. ESD pulse is applied between the pins (VIDEO\_1; VIDEO\_2; VIDEO\_3; SYNC\_OUT1; SYNC\_OUT2; DCC\_OUT1; DCC\_OUT2) and GND.

[2] According to IEC 61000-4-2, level 3, contact discharge.

[3] Machine model according to ESD22-A115-A.

[4] Human Body Model (HBM) according to JESD22-A-J114D.

## 6. Recommended operating conditions

Table 4.	Recommended operating conditions						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
T <sub>amb</sub>	ambient temperatu	re	-40	-	+85	°C	

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## 7. Characteristics

#### Table 5. Analog video (R, G, B) characteristics

 $V_{CC(VIDEO)} = 5$  V;  $T_{amb} = 25$  °C; unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
I <sub>CC</sub>	supply current	static input signals	-	-	10	μA
C <sub>ch</sub>	channel capacitance	$    f = 1 MHz;     V_I = 2.5 V_{(p-p)};     V_{bias} = 2.5 V $	<u>[1]</u> _	-	4	pF
I <sub>i(video)</sub>	video input current	$V_{IN} = V_{CC(VIDEO)}$ or $V_{IN} = GND$	-1	-	+1	μΑ
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 mA	-	0.7	-	V

[1] This parameter is guaranteed by design and characterization.

#### Table 6. DDC level shifter characteristics

 $V_{CC(DDC)} = 5 V$ ;  $T_{amb} = 25$ °C; unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>ch</sub>	channel capacitance	$    f = 1 \text{ MHz}; \\ V_{I} = 2.5 V_{(p-p)}; \\ V_{bias} = 2.5 V $	<u>[1]</u> -	-	4	pF
R <sub>dyn</sub>	dynamic resistance	I = 1 A	[2]			
		positive transient	-	-	2.4	Ω
		negative transient	-	-	1.3	Ω
V <sub>CL</sub>	clamping voltage	V <sub>ESD</sub> = 8 kV; positive transient	<u>[3]</u> _	8	-	V
$\Delta V_{on}$	on-state voltage drop		[4]	85	140	mV
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 mA	-	0.7	-	V

[1] This parameter is guaranteed by design and characterization.

[2] According to IEC 61000-4-5 and IEC 61000-4-9.

[3] According to IEC 61000-4-2, contact discharge.

[4] For level shifting N-FET.

#### Table 7. SYNC protection characteristics

 $V_{CC(SYNC)} = 5$  V;  $T_{amb} = 25$  °C; unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>ch</sub>	channel capacitance	$    f = 1 \text{ MHz}; \\ V_{CC(SYNC)} = 2.5 \text{ V}_{(p-p)}; \\ V_{bias} = 2.5 \text{ V} $	<u>[1]</u> -	-	4	pF
V <sub>F</sub>	forward voltage	l <sub>F</sub> = 1 mA	-	0.7	-	V

[1] This parameter is guaranteed by design and characterization.

## 8. Application information

To maximize ESD clamping performance, the IP4769CZ14 should be placed as close as possible to the VGA/DVI connector. The ESD protection channels VIDEO\_1, VIDEO\_2 and VIDEO\_3 are identical and can be connected in any order with R, B, G signals to simplify routing, and minimize stubs and vias. The SYNC protection lines are also identical and can be used in any order for HSYNC or VSYNC signals. The DDC level shifter lines are likewise identical in function.

The pull-up resistors on the DDC lines are dictated by the application, depending on the values of the internal pull-ups provided in the Application-Specific Integrated Circuit (ASIC), etc. Weak pull-ups may be required, for example, to pull up the DDC\_INx lines to VCC\_5V when no monitor is connected, if the local ASIC does not include internal pull-ups. Unexpected backdrive current can flow through these resistors though, when an external monitor is powered and the local VCC\_5V is powered down. Backdrive protection should be considered if this is a concern.



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## 9. Package outline



#### Fig 4. Package outline SOT402-1 (TSSOP14/MO-153)

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## **10. Revision history**

Table 8. Re	evision history				
Document ID	)	Release date	Data sheet status	Change notice	Supersedes
IP4769CZ14 \	<i>v</i> .1	20110117	Product data sheet	-	-

## **11. Legal information**

### 11.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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## IP4769CZ14

VGA interface ESD protection with integrated termination resistors

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